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<td>PCB, Antenna, There is nothing to buy or install.</td>
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<td>WE 850 080 275 017</td>
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<td>TP2, TP3</td>
<td>DNP</td>
<td>TEST POINT SLOTTED 1/8&quot; TR</td>
<td>Keystone</td>
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<td>42</td>
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<td>Buck Step Down Regulator with 1.9 to 3.9 V input and 2.1 V output, -40 to 85 degC, 6-Pin SON (DRY), Green (RoHS &amp; no Sb/Br)</td>
<td>Texas Instruments</td>
<td>TPS62730DRYR</td>
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<td>MSP3430F14133FLM</td>
<td>16-bit Ultra-Low-Power MCU</td>
<td>Texas Instruments</td>
<td>MSP430FR4133FLM</td>
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<td>Sub-1 GHz and 2.4 GHz Multi-standard RF IC Family, 80-Pin LFQFP</td>
<td>Texas Instruments</td>
<td>CC1310F128AQR</td>
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<td>Micro Crystal AG</td>
<td>MBV-Y TR 32.768KHZ</td>
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